Switching Diodes Panasonic

MA26111

Silicon epitaxial planar type

For switching circuits

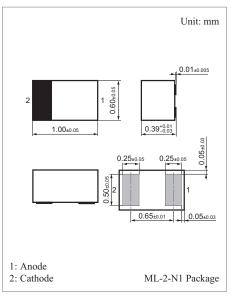
■ Features

- Allowing high-density mounting
- Short reverse recovery time t_{rr}
- Small terminal capacitance C_t
- High breakdown voltage: V_{RI}=80 V

■ Absolute Maximum Ratings $T_{a'} = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	V_R	80	V	
Maximum peak reverse voltage	V_{RM}	80	V	
Forward current	I_{F}	100	mA	
Peak forward current	I_{FM}	225	mA	
Non-repetitive peak forward surge current *	I_{FSM}	500	mA	
Junction temperature	T _j	125	°C	
Storage temperature	T _{stg}	-55 to +125	°C	





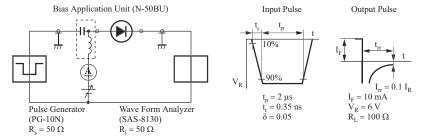
Marking Symbol: 1

■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm F}$	$I_F = 100 \text{ mA}$		0.95	1.2	V
Reverse voltage	V _R	$I_{R} = 100 \ \mu A$	80			V
Reverse current	I_R	V _{RI} = 75 V			100	nA
Terminal capacitance	C _t	$V_{RJ} = 0$, $f = 1$ MHz		0.6	2	pF
Reverse recovery time *	t _{rr}	$ I_F = 10 \text{ mA}, V_{RI} = 6 \text{ V}, I_{IF} = 0.1 I_{R_I}, R_{LI} = 100 \Omega$			3	ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

- 2. Absolute frequency of input and output is 100 MHz
- 3. . *: t_{rr} measurement circuit



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